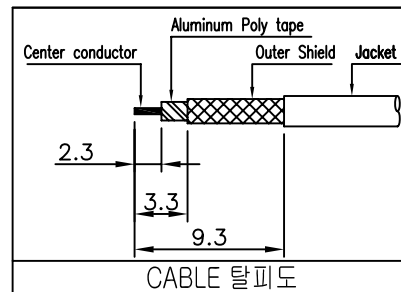
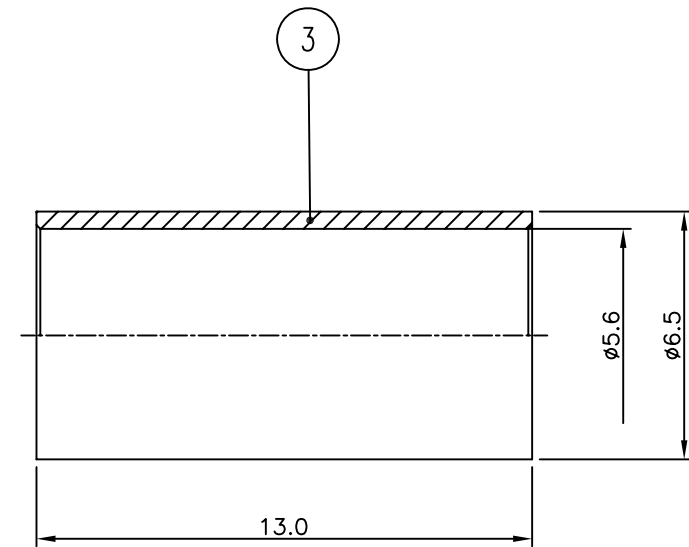
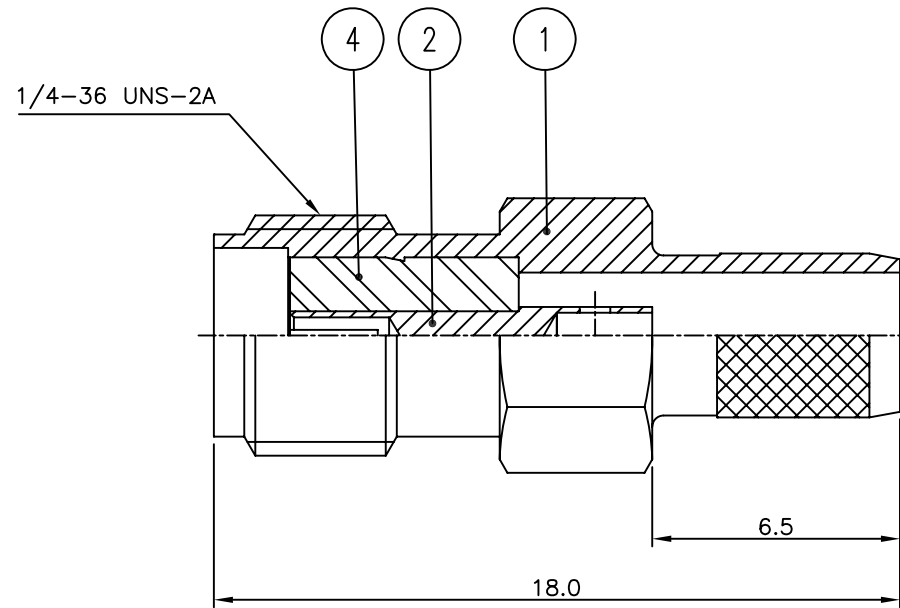


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2017.04.17.
1	커넥터 압착부 바디 부러짐 현상 방지로 인한 R추가	S.Y.EUN	S.H.KIM	2022.01.03.



4	INSULATOR	1	TEFLON		DIN02133-N/1
3	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DFE00059-5/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03831-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04309-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2022. 01. 03.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	S.H.KIM	
MATERIAL	-	CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 CABLE JS LMR200(50Ω)
		DRAWN BY	S.Y.EUN	
FINISH	-	SCALE	5/1	A4 DWG NO. CN03690-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	